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- **EPIC™** (Enhanced-Performance Implanted **CMOS) Process**
- Operating Range 2-V to 5.5-V V_{CC}
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- **Package Options Include Plastic** Small-Outline (DW), Shrink Small-Outline (DB), Thin Very Small-Outline (DGV), Thin Shrink Small-Outline (PW), and Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) DIPs

description

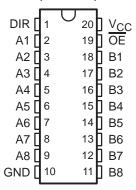
The 'AHC245 octal bus transceivers are designed for asynchronous two-way communication between data buses. The control-function implementation minimizes external requirements.

These devices allow data transmission from the A bus to the B bus or from the B bus to the A bus. depending on the logic level at the direction-control (DIR) input. The output-enable (OE) input can be used to disable the device so that the buses are effectively isolated.

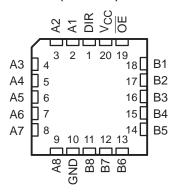
To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54AHC245 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74AHC245 is characterized for operation from -40°C to 85°C.

SN54AHC245 . . . J OR W PACKAGE SN74AHC245 . . . DB, DGV, DW, N, OR PW PACKAGE (TOP VIEW)



SN54AHC245 . . . FK PACKAGE (TOP VIEW)



FUNCTION TABLE (each transceiver)

INP	UTS	OPERATION				
ŌĒ	DIR	OPERATION				
L	L	B data to A bus				
L	Н	A data to B bus				
Н	Χ	Isolation				

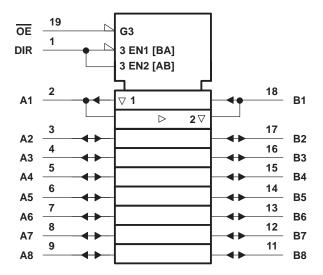


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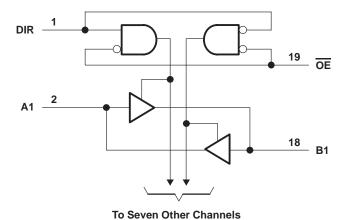


logic symbol†



 $[\]ensuremath{^{\dagger}}$ This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}		–0.5 V to 7 V
Input voltage range, V _I (see Note 1)		0.5 V to 7 V
Output voltage range, VO (see Note 1)		-0.5 V to $V_{CC} + 0.5 \text{ V}$
Input clamp current, I _{IK} (V _I < 0)		
Output clamp current, IOK (VO < 0 or VO > VCO	E)	±20 mA
Continuous output current, $I_O(V_O = 0 \text{ to } V_{CC})$	······	±25 mA
Continuous current through V _{CC} or GND		±75 mA
Package thermal impedance, θ_{JA} (see Note 2):		
3 , ()	DGV package	
	DW package	58°C/W
	N package	69°C/W
	PW package	83°C/W
Storage temperature range, T _{stg}	, -	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions (see Note 3)

			SN54A	HC245	SN74A	HC245	UNIT	
			MIN	MAX	MIN	MAX	UNII	
Vcc	Supply voltage		2	5.5	2	5.5	V	
		V _{CC} = 2 V	1.5		1.5			
V_{IH}	High-level input voltage	V _{CC} = 3 V	2.1		2.1		V	
		V _{CC} = 5.5 V	3.85		3.85			
		V _{CC} = 2 V		0.5		0.5		
V_{IL}	Low-level input voltage	V _{CC} = 3 V		0.9		0.9	V	
		V _{CC} = 5.5 V		1.65		1.65		
٧ _I	Input voltage	OE or DIR	0	5.5	0	5.5	V	
٧o	Output voltage	A or B	0	Vcc	0	Vcc	V	
		V _{CC} = 2 V	Т	-50		-50	μΑ	
loh	High-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		-4		-4	A	
		$V_{CC} = 5 V \pm 0.5 V$		-8		-8	mA	
		V _{CC} = 2 V		50		50	μΑ	
I_{OL}	Low-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		4		4	mA	
		$V_{CC} = 5 V \pm 0.5 V$		8		8		
A+/A>.	langet transition rice or fall rate	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		100		100	20/1	
$\Delta t/\Delta v$	Input transition rise or fall rate $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$			20		20	ns/V	
TA	Operating free-air temperature	•	-55	125	-40	85	°C	

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



SN54AHC245, SN74AHC245 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V	T,	Δ = 25°C	;	SN54AHC245		SN74AHC245		LINUT
PA	RAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
VOH			2 V	1.9	2		1.9		1.9		
		I _{OH} = -50 μA	3 V	2.9	3		2.9		2.9		
			4.5 V	4.4	4.5		4.4		4.4		V
		I _{OH} = -4 mA	3 V	2.58			2.48		2.48		
		I _{OH} = -8 mA	4.5 V	3.94			3.8		3.8		
			2 V			0.1		0.1		0.1	
		ΙΟL = 50 μΑ	3 V			0.1		0.1		0.1	.
VOL			4.5 V			0.1		0.1		0.1	V
		$I_{OL} = 4 \text{ mA}$	3 V			0.36		0.5		0.44	
		I _{OL} = 8 mA	4.5 V			0.36		0.5		0.44	
Γ.	A or B inputs	V VOND	5.5 V			±0.1		±1		±1	•
1 ₁	OE or DIR	$V_I = V_{CC}$ or GND	0 V to 5.5 V			±0.1		±1*		±1	μΑ
loz†		$V_O = V_{CC}$ or GND, $V_I (\overline{OE}) = V_{IL}$ or V_{IH}	5.5 V			±0.25		±2.5		±2.5	μΑ
Icc		$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			4		40		40	μΑ
Ci	OE or DIR	V _I = V _{CC} or GND	5 V		2.5	10				10	pF
C _{io}	A or B inputs	V _I = V _{CC} or GND	5 V		4						pF

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested at $V_{CC} = 0 \text{ V}$.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	T,	_λ = 25°(С	SN54A	HC245	SN74A	HC245	UNIT
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
tPLH	A or B	B or A	C 15 pE		5.8**	8.4**	1**	10**	1	10	ns
t _{PHL}	AOIB	BOIA	C _L = 15 pF		5.8**	8.4**	1**	10**	1	10	115
^t PZH	ŌĒ	A or B	C _L = 15 pF		8.5**	13.2**	1**	15.5**	1	15.5	ns
t _{PZL}	OE	AOIB	CL = 13 pr		8.5**	13.2**	1**	15.5**	1	15.5	115
^t PHZ	ŌĒ	A or B	C _I = 15 pF		8.9**	12.5**	1**	15.5**	1	15.5	ns
t _{PLZ}	OE	AOIB	CL = 13 pr		8.9**	12.5**	1**	15.5**	1	15.5	115
t _{PLH}	A or B	B or A	C _I = 50 pF		8.3	11.9	1	13.5	1	13.5	ns
^t PHL	AOIB	BOIA	CL = 30 pr		8.3	11.9	1	13.5	1	13.5	115
^t PZH	ŌĒ	A or B	C _L = 50 pF		11	16.7	1	19	1	19	ns
t _{PZL}	OE	AOIB	CL = 30 pr		11	16.7	1	19	1	19	115
t _{PHZ}	ŌĒ	A or B	C _I = 50 pF		11.5	15.8	1	18	1	18	ns
t _{PLZ}	OE	AOIB	CL = 30 pr		11.5	15.8	1	18	1	18	115
tsk(o)			C _L = 50 pF			1.5***				1.5	ns

^{**} On products compliant to MIL-PRF-38535, this parameter is not production tested.



[†] The parameter IOZ includes the input leakage current.

^{***} On products compliant to MIL-PRF-38535, this parameter does not apply.

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switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

DADAMETER	FROM	то	LOAD	T,	4 = 25°C	;	SN54AI	HC245	SN74A	HC245	UNIT
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
t _{PLH}	A or B	B or A	C _I = 15 pF		4*	5.5*	1*	6.5*	1	6.5	ns
t _{PHL}	AOIB	BULA	CL = 13 pr		4*	5.5*	1*	6.5*	1	6.5	115
^t PZH	<u>OE</u>	A or B	C _I = 15 pF		5.8*	8.5*	1*	10*	1	10	ns
tPZL	OE	AOIB	GL = 13 pr		5.8*	8.5*	1*	10*	1	10	115
^t PHZ	ŌĒ	A or B	C _L = 15 pF		5.6*	7.8*	1*	9.2*	1	9.2	ns
tPLZ	OE	AUB	GE = 13 bis		5.6*	7.8*	1*	9.2*	1	9.2	10
t _{PLH}	A or B	B or A	C _I = 50 pF		5.5	7.5	1	8.5	1	8.5	ns
t _{PHL}	AOIB	BULA	CL = 30 pr		5.5	7.5	1	8.5	1	8.5	110
^t PZH	ŌĒ	A or B	C _I = 50 pF		7.3	10.6	1	12	1	12	ns
t _{PZL}	OE	AUB	GL = 30 pr		7.3	10.6	1	12	1	12	115
t _{PHZ}	ŌĒ	A or B	C _L = 50 pF		7	9.7	1	11	1	11	ns
t _{PLZ}	OE	AUIB	GL = 50 pr		7	9.7	1	11	1	11	115
^t sk(o)			C _L = 50 pF			1**				1	ns

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.

noise characteristics, $V_{CC} = 5 \text{ V}$, $C_L = 50 \text{ pF}$, $T_A = 25^{\circ}\text{C}$ (see Note 4)

	PARAMETER	SN7	UNIT		
	PARAMETER	MIN	TYP	MAX	UNIT
V _{OL(P)}	Quiet output, maximum dynamic V _{OL}		0.9		V
V _{OL(V)}	Quiet output, minimum dynamic VOL		-0.9		V
VOH(V)	Quiet output, minimum dynamic VOH		4.3		V
V _{IH(D)}	High-level dynamic input voltage	3.5			V
V _{IL(D)}	Low-level dynamic input voltage			1.5	V

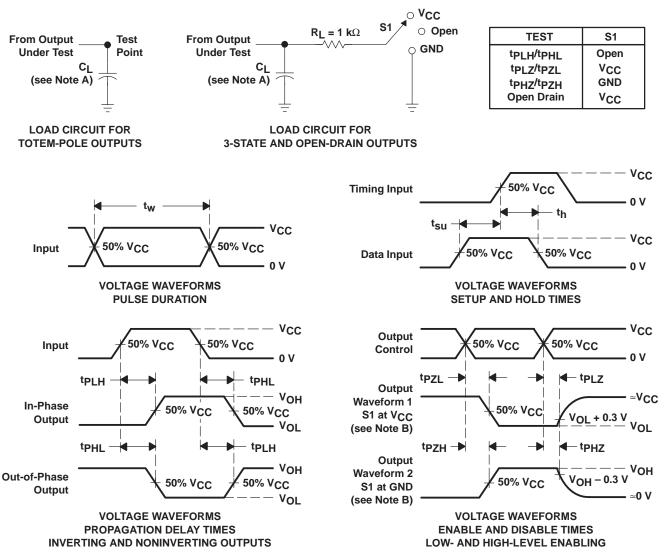
NOTE 4: Characteristics are for surface-mount packages only.

operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd} Power dissipation capacitance	No load, f = 1 MHz	14	pF

^{**} On products compliant to MIL-PRF-38535, this parameter does not apply.

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \ \Omega$, $t_f \leq 3 \ ns$, $t_f \leq 3 \ ns$.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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